

Data sheet acquired from Harris Semiconductor SCHS027C – Revised February 2004

# CMOS Counter/Dividers

High-Voltage Types (20-Volt Rating) CD4017B—Decade Counter with

**10 Decoded Outputs** 

#### CD4022B-Octal Counter with

8 Decoded Outputs

■ CD4017B and CD4022B are 5stage and 4-stage Johnson counters having 10 and 8 decoded outputs, respectively. Inputs include a CLOCK, a RESET, and a CLOCK INHIBIT signal. Schmitt trigger action in the CLOCK input circuit provides pulse shaping that allows unlimited clock input pulse rise and fall times.

These counters are advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. A high RESET signal clears the counter to its zero count. Use of the Johnson counter configuration permits high-speed operation, 2-input decode-gating and spike-free decoded outputs. Anti-lock gating is provided, thus assuring proper counting sequence. The decoded outputs are normally low and go high only at their respective decoded time slot. Each decoded output remains high for one full clock cycle. A CARRY-OUT signal completes one cycle every 10 clock input cycles in the CD4017B or every 8 clock input cycles in the CD4022B and is used to ripple-clock the succeeding device in a multi-device counting chain.

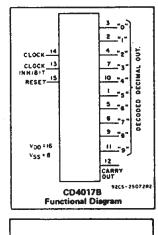
#### Features:

- Fully static operation
- Medium-speed operation . . .
- 10 MHz (typ.) at V<sub>DD</sub> = 10 V
- Standardized, symmetrical output **characteristics**
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"

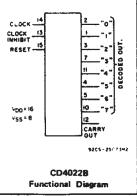
#### Applications:

- Decade counter/decimal decode display (CD4017B)
- Binary counter/decoder
- **Frequency division**
- Counter control/timers
- . **Divide-by-N counting**
- For further application information, see ICAN-6166 "COS/MOS MSI Counter and Register Design and **Applications**"

The CD4017B and CD4022B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic package (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4017B types also are supplied in 16-lead small-outline packages (M and M96 suffixes).



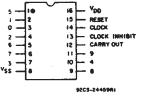
**CD4017B, CD4022B Types** 

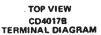


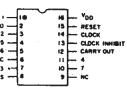
#### **RECOMMENDED OPERATING CONDITIONS**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTICS  | V <sub>DD</sub> | LIN               | UNITS           |      |  |
|--|-----------------|-------------------|-----------------|------|--|
|  | (V)             | Min.              | Max.            |      |  |
| Supply-Voltage Range (For T <sub>A</sub> = Full Package-<br>Temperature Range) |                 | 3                 | 18              | v    |  |
| Clock Input Frequency, f <sub>CL</sub>   | 5<br>10<br>15   | 1   1             | 2.5<br>5<br>5.5 | MHz  |  |
| Clock Pulse Width, t <sub>W</sub>  | 5<br>10<br>15   | 200<br>90<br>60   |                 | . ns |  |
| Clock Rise & Fall Time, t <sub>rCL</sub> , t <sub>fCL</sub>                    | 5<br>10<br>15   | UNLIN             | NITED*          | ·*.  |  |
| Clock Inhibit Setup Time, t <sub>s</sub>                                       | 5<br>10<br>15   | 230<br>100<br>70  | -               | ns   |  |
| Reset Pulse Width, t <sub>RW</sub>   | 5<br>10<br>15   | 260<br>110<br>60  |                 | ns   |  |
| Reset Removal Time, t <sub>rem</sub>   | 5<br>10<br>15   | 400<br>280<br>150 |                 | ns   |  |



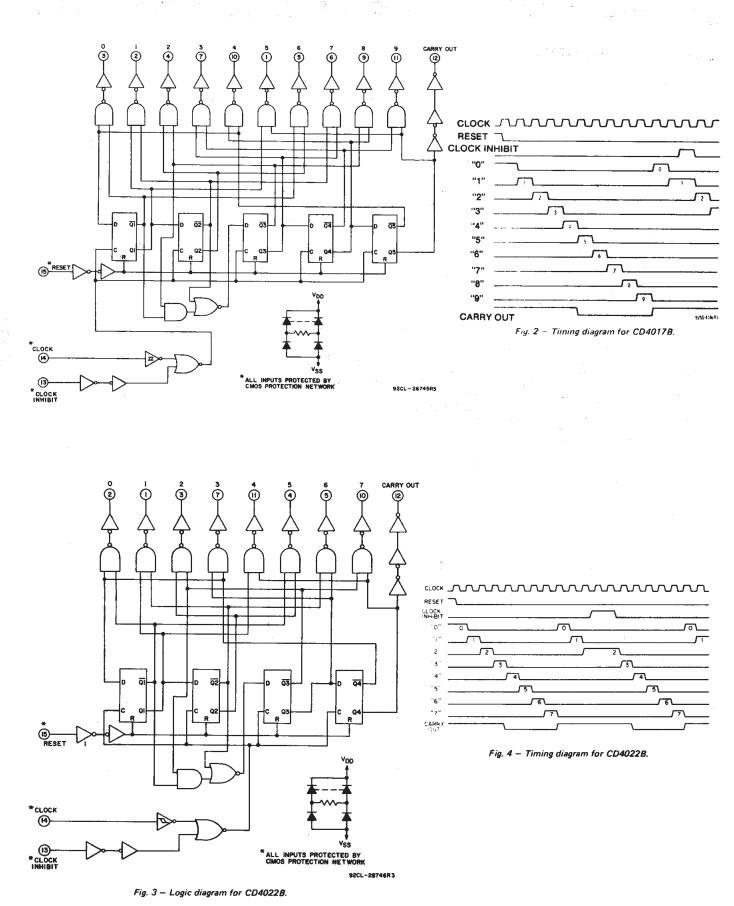




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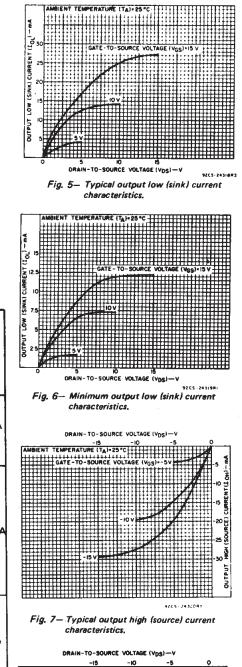
TOP VIEW NC - no connection CD4022B TERMINAL DIAGRAM

\*Only if Pin 14 is used as the clock input. If Pin 13 is used as the clock input and Pin 14 is tied high (for advancing count on negative transition of the clock), rise and fall time should be  $\leq$  15  $\mu$ s.



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| MAXIMUM RATINGS, Absolute-Maximum Values:   |  |
|---|--|
| DC SUPPLY-VOLTAGE RANGE, (VDD)  |  |
| Voltages referenced to V <sub>SS</sub> Terminal)  | 0.5V to +20V                                     |
| INPUT VOLTAGE RANGE, ALL INPUTS   | 0.5V to V <sub>DD</sub> +0.5V                    |
| DC INPUT CURRENT, ANY ONE INPUT   | ±10mA  |
| POWER DISSIPATION PER PACKAGE (PD):   |  |
| For $T_A = -55^{\circ}C$ to $+100^{\circ}C$   |  |
|   |  |
| For T <sub>A</sub> = +100°C to +125°C D   | erate Linearity at 12mW/ <sup>0</sup> C to 200mW |
| For TA = +100°C to +125°CD<br>DEVICE DISSIPATION PER OUTPUT TRANSISTOR  | erate Linearity at 12mW/ <sup>o</sup> C to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR  |  |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR<br>FOR T <sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Package T<br>OPERATING-TEMPERATURE RANGE (T <sub>A</sub> ) | ypes)  |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR<br>FOR T <sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Package T<br>OPERATING-TEMPERATURE RANGE (T <sub>A</sub> ) | ypes)  |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR<br>FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package T  | ypes)  |



3

COMMERCIAL CMOS HIGH VOLTAGE ICS

# DRAIN-TO-SOURCE VOLTAGE (VDg)-V -15 -10 -5 0 AMMEENT TEMPERATURE (Vg)-25 C -10 -5 0 -5 0 AMMEENT TEMPERATURE (Vg)-25 C -10 -5 0 -5 0 -5 0 -5 0 -5 0 -5 0 -5 0 -6 0 -6 0 -6 0 -6 0 -6 0 -6 -7 -5 -7 -8 -6 -7 -5 -7 -6 -7 -7 -6 -7

#### STATIC ELECTRICAL CHARACTERISTICS

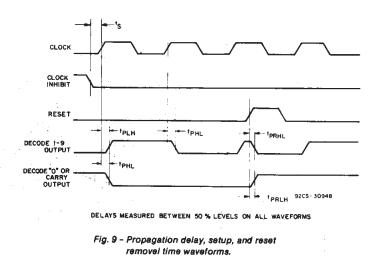
| CHARAC-<br>TERISTIC                             | CONDITIONS     |              |     | LIMITS AT INDICATED TEMPERATURES ( <sup>O</sup> C) |       |       |       |       |                   |      | U N<br>I<br>T |
|---|----------------|--------------|-----|--|-------|-------|-------|-------|-------------------|------|---------------|
|   | v <sub>o</sub> |              |     |  |       |       |       | +25   |                   |      | S             |
|   | (Ň)            | (V)          | (v) | 55   | 40    | +85   | +125  | Min.  | Тур.              | Max. |               |
| Quiescent                                       | _              | 0,5          | 5   | 5  | 5     | 150   | 150   | -     | 0.04              | 5    |               |
| Device  | -              | 0,10         | 10  | 10   | 10    | 300   | 300   | -     | 0.04              | 10   | μA            |
| Current,  | _              | 0,15         | 15  | 20   | 20    | 600   | 600   | -     | 0.04              | 20   | ľ             |
| IDD Max.  | -              | 0,2 <b>0</b> | 20  | 100  | 100   | 3000  | 3000  | -     | 0.08              | 100  |               |
| Output Low                                      | 0.4            | 0,5          | 5   | 0.64   | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | -    |               |
| (Sink) Current                                  | 0.5            | 0,10         | 10  | 1.6  | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | -    |               |
| IOL Min.  | 1.5            | 0,15         | 15  | 4.2  | 4     | 2.8   | 2.4   | 3.4   | 6.8               | -    |               |
| Qutout High                                     | 4.6            | 0,5          | 5   | -0.64  | -0.61 | -0.42 | -0.36 | -0.51 | -1                | -    | ]m/           |
| Output High<br>(Source)<br>Current,<br>IOH Min. | 2.5            | 0,5          | 5   | -2   | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | -    |               |
|   | 9.5            | 0,10         | 10  | -1.6   | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | -    |               |
|   | 13.5           | 0,15         | 15  | -4.2   | -4    | -2.8  | -2.4  | -3.4  | -6.8              | -    |               |
| Output Voltage:                                 |                | 0,5          | 5   |  | 0     | _     | 0     | 0.05  |                   |      |               |
| Low Level,                                      |                | 0,10         | 10  |  | 0     |       | 0     | 0.05  | ]                 |      |               |
| VOL Max.  | -              | 0,15         | 15  |  | 0     | -     | 0     | 0.05  | ] v               |      |               |
| Output  | -              | 0,5          | 5   | 4.95   |       |       |       |       | 5                 | _    |               |
| Voltage:  |                | 0,10         | 10  |  | 9     | 9.95  | 10    | -     | ]                 |      |               |
| High-Level,<br>V <sub>OH</sub> Min.             | -              | 0,15         | 15  |  | 14    | 14.95 | 15    | · -   | ]                 |      |               |
| 4   | 0.5,4.5        | ·            | 5   |  |       | -     | -     | 1.5   | ┢                 |      |               |
| Input Low<br>Voltage                            | 1,9            | _            | 10  | 3  |       |       |       |       | -                 | 3    | ]             |
| VIL Max.  | 1.5,13.5       | -            | 15  |  |       |       | —     | 4     | ] v               |      |               |
| Input High                                      | 0.5,4.5        | -            | 5   | 3.5  |       |       |       | 3.5   | -                 | -    |               |
| Voltage,  | 1,9            | -            | 10  | 7  |       |       |       |       | -                 | -    | ]             |
| V <sub>EH</sub> Min.                            | 1.5,13.5       | -            | 15  | 11   |       |       |       |       | -                 | -    |               |
| Input Current<br>IIN Max.                       | -              | 0,18         | 18  | ±0.1 ±0.1 ±1 ±1                                    |       |       |       |       | ±10 <sup>-5</sup> | ±0.1 | μ             |

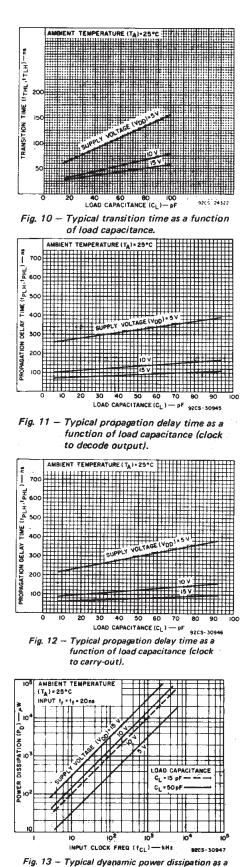
#### DYNAMIC ELECTRICAL CHARACTERISTICS

At T<sub>A</sub> = 25°C, Input t<sub>r</sub>, t<sub>f</sub> = 20 ns, C<sub>L</sub> = 50 pF, R<sub>L</sub> = 200 k $\Omega$ 

| CHARACTERISTIC  | CONDITIONS          | LIMITS    |          |          | UNITS |
|---|---------------------|-----------|----------|----------|-------|
| -   | V <sub>DD</sub> (V) | Min.      | Тур.     | Max.     | UNITS |
| CLOCKED OPERATION   |                     |           | <b>-</b> | <b>.</b> |       |
|   | 5                   | _         | 325      | 650      |       |
| Propagation Delay Time, tpHL, tpLH                            | 10                  | -         | 135      | 270      |       |
| Decode Out  | 15                  | -         | 85       | 170      | ns    |
|   | 5                   | -         | 300      | 600      |       |
| Carry Out   | 10                  |           | 125      | 250      |       |
| :   | 15                  |           | 80       | 160      |       |
| Transition Time, tTHL, tTLH                                   | 5                   | _         | 100      | 200      |       |
| Carry Out or Decode Out Line                                  | 10                  | _         | 50       | 100      | ns    |
|   | 15                  | -         | 40       | 80       |       |
|   | 5                   | 2.5       | 5        | -        |       |
| Maximum Clock Input Frequency, fCL*                           | 10                  | 5         | 10       | _        | MHz   |
|   | 15                  | 5.5       | 11       | -        | _     |
|   | 5                   | _         | 100      | 200      |       |
| Minimum Clock Pulse Width, tw                                 | 10                  | _         | 45       | 90       | ns    |
| -   | 15                  | -         | 30       | 60       |       |
| Clock Rise or Fall Time, t <sub>r</sub> CL, t <sub>f</sub> CL | 5, 10, 15           | UNLIMITED |          |          |       |
| Minimum Clock Inhibit   | 5                   |           | 115      | 230      |       |
| to Clock Setup Time, t <sub>s</sub>                           | 10                  | _         | 50       | 100      | ns    |
|   | 15                  |           | 35       | 70       |       |
| Input Capacitance, CIN  | Any Input           | -         | 5        | _        | рF    |
| RESET OPERATION   | · · ·               |           |          | ÷        |       |
| Propagation Delay Time, tPHL, tPLH                            | 5                   | _         | 265      | 530      |       |
| Carry Out or Decode Out Lines                                 | 10                  | _         | 115      | 230      | ns    |
|   | 15                  | -         | 85       | 170      |       |
|   | 5                   | _         | 130      | 260      |       |
| Minimum Reset Pulse Width, tw                                 | 10                  | -         | 55       | 110      | ns    |
|   | 15                  | -         | 30       | 60       |       |
|   | 5                   |           | 200      | 400      |       |
| Minimum Reset Removal Time                                    | 10                  | _         |          | 280      | ns    |
|   | 15                  | _         | 75       | 150      |       |

\* Measured with respect to carry output line.





function of clock input frequency.

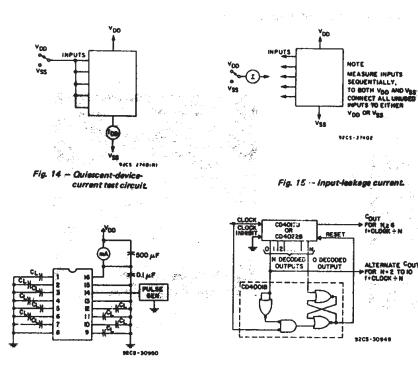
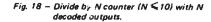
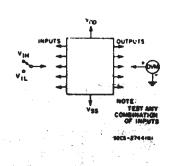


Fig. 17 - Dynamic power dissipation test circuit.





#### Fig. 16 - Input-voltage test circuit.

When the Nth decoded output is reached (Nth clock pulse) the S-R flip flop (constructed from two NOR gates of the CD4001B) generates a reset pulse which clears the CD4017B or CD4022B to its zero count. At this time, if the Nth dacoded output is greater than or equal to 6 in the CD-4017B or 5 in the CD4022B, the COUT line goes high to clock the next CD4017B or CD-4022B counter section. The "0" decoded output also goes high at this time. Coincidence of the clock low and decoded "0" output low resets the S-R flip flop to enable the CD4017B or CD4022B. If the Nth decoded output is less than 6 (CD4017B) or 5 (CD4022B), the COUT line will not go high and, therefore, cannot be used. in this case "0" decoded output may be used to perform the clocking function for the next counter.



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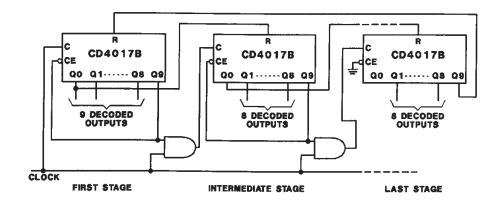
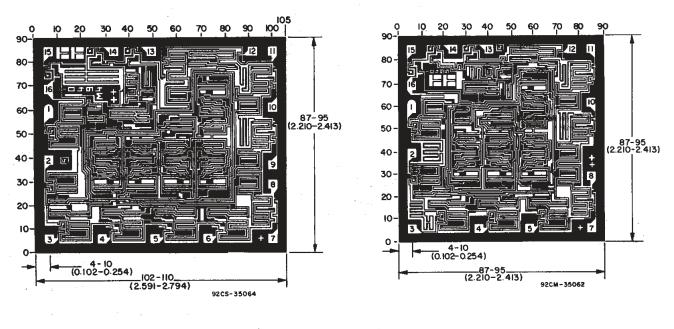


Fig. 19 - Cascading the CD4017B.

#### CHIP DIMENSIONS AND PAD LAYOUTS



CD4017BH

in Tae

CD4022BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3}$  inch).

### PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup>               |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|--|
| 89270AKB3T       | OBSOLETE              |                 |                    | 0    |                | None                    | Call TI          | Call TI                                    |
| CD4017BE         | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-NC-NC-NC                             |
| CD4017BF         | ACTIVE                | CDIP            | J                  | 16   | 1              | None                    | Call TI          | Level-NC-NC-NC                             |
| CD4017BF3A       | ACTIVE                | CDIP            | J                  | 16   | 1              | None                    | Call TI          | Level-NC-NC-NC                             |
| CD4017BM         | ACTIVE                | SOIC            | D                  | 16   | 40             | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| CD4017BM96       | ACTIVE                | SOIC            | D                  | 16   | 2500           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| CD4017BNSR       | ACTIVE                | SO              | NS                 | 16   | 2000           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| CD4017BPW        | ACTIVE                | TSSOP           | PW                 | 16   | 90             | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-1-250C-UNLIM                         |
| CD4017BPWR       | ACTIVE                | TSSOP           | PW                 | 16   | 2000           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-1-250C-UNLIM                         |
| CD4022BE         | ACTIVE                | PDIP            | Ν                  | 16   | 25             | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-NC-NC-NC                             |
| CD4022BF         | ACTIVE                | CDIP            | J                  | 16   | 1              | None                    | Call TI          | Level-NC-NC-NC                             |
| CD4022BF3A       | ACTIVE                | CDIP            | J                  | 16   | 1              | None                    | Call TI          | Level-NC-NC-NC                             |
| CD4022BNSR       | ACTIVE                | SO              | NS                 | 16   | 2000           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| CD4022BPW        | ACTIVE                | TSSOP           | PW                 | 16   | 90             | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-1-250C-UNLIM                         |
| CD4022BPWR       | ACTIVE                | TSSOP           | PW                 | 16   | 2000           | Pb-Free<br>(RoHS)       | CU NIPDAU        | Level-1-250C-UNLIM                         |
| JM38510/05651BEA | ACTIVE                | CDIP            | J                  | 16   | 1              | None                    | Call TI          | Level-NC-NC-NC                             |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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28-Feb-2005

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J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



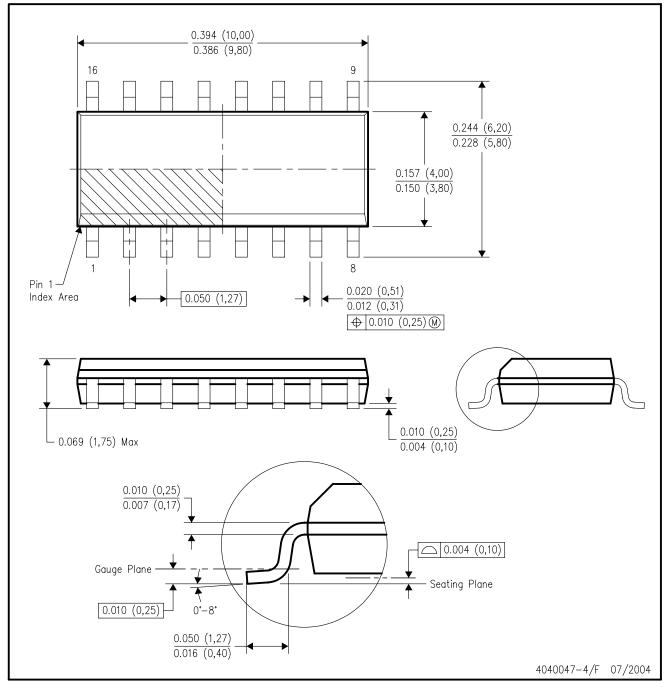
NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.



# MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



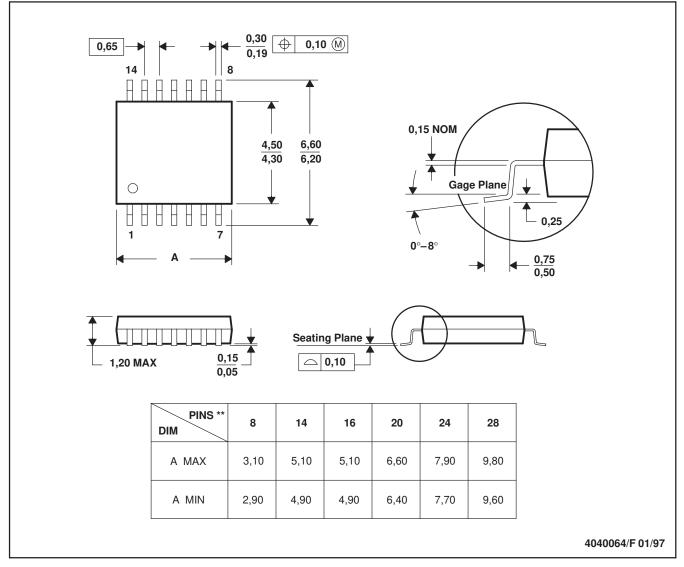
# **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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